

SANYO Semiconductors DATA SHEET

CMOS LSI

Controller for The LC Dot Matrix Graphic Display

Summary

The LC7981 is a controller LSI for the liquid crystal dot matrix graphic display. It stores display data sent from the 8-bit microcomputer in the display RAM attached externally and generates dot matrix LC drive signals. The LC7981 has two modes — the graphic mode, in which each bit of data from the external RAM either lights or does not light a dot in the LCD, and the character mode, in which character codes stored in the external RAM generate dot patterns through the built-in character-generator ROM. These two ways enable the LC7981 to cover a wide variety of applications.

As the LC7981 is fabricated using CMOS process technology, combining it with a CMOS microcomputer produces an LCD device of low power demand.

Features

- 1. Liquid crystal dot matrix graphic display controller
- Display control capacity. Graphic mode ----- 512K dots (2¹⁶ bytes) Character mode ----- 4096 characters (2¹² characters)
 Character mode ------ 2006 characters (2¹² characters)
- 3. Character generator ROM ----- 7360 bits Character font 5 x 7 dots 160 types Total 192 types Character font 5 x 11 dots 32 types (Extendable to 4K bytes with an external ROM)
- 4. Interfacing allowed with 8-bit MPU
- Display duty (selectable by program) From static to 1/256 duty
- 6. A variety of instruction functions Scroll, cursor on/off/blink, character blink, bit manipulation
- 7. Display system ---- A system or B system selectable
- 8. Built-in oscillator (resistor, capacitor attached externally)
- 9. Low power demand
- 10. Single +5V power supply





bsolute Maximum Ratings/Ta [.]	=25°C, GNI	D=0V				101.00.000
Maximum Supply Voltage	Vpp max		-0 -	3to+7	0	unit
Input Voltage	VI		-0.3to	(00+0	3	v
Outout Voltage	Vo		-0.3+00	0010. bo⊥0	2	Ň
Allowable Power Dissipation	Pd max	Ta=75%	-0.510	DUTU.	0	V milli
Operating Temperature	Toor	10-750	1/1000	20	Y	mvv
Storage Temperature	Tota			2010+7	S. C. S.	U v
Storage Temperature	ISIS	+		oto+12	5	\mathbf{r}
Allowable Operating Conditions	s/T _a =—20 t	o +75°C, GND=0∨	- mo	100	mak	
Supply Voltage	Voo		4 75	CO P	8.25	V
Input "H"-Level Voltage	VIH	All input, I/O terminals except for SYNC, C	R 22		Voo	v
Input "L"-Level Voltage	Viit				0.8	V
Input "H"-1 evel Voltage	Villa	SVNC CR	0 7 7) (pp		Veo	v
Input "I " Level Voltage	VIII O	EXNIC OD	G. TVDL			V
	VILZ	STINC, CR	~ 9/	e.	U-3VDD	V
Output "H"-Level Voltage	VOHI	DB0to7, WE, MA0to15, MD0to7	2.4		VDD	V
Output "L"-Level Voltage	VOL1	IOL=1.6mA DB0to7, WE, MA0to15, MD0to7	0		0.4	V
Output "H"-Level Voltage	VOH2	IOH=-0.6mA	Voo-0	. 4	VDD	V
Output "L"-Level Voltage	Vol2	D1. D2, MA, MB IOL=8.6mA SYNC, CPO, FLM, CL1/CL2, D1. 02, MA, MB	٥		0.4	v
nternal Clock Operation	s /					
Clock OSC Frequency	tosc /	$Cf = 150P \pm 5.96$, $Rf = 39k\Omega \pm 2.96$, Note 1	500	600	700	kHz
xternal Clock Operation	seed.					
Clock Frequency	f¢P	Note 2			2.5	MHz
Clock Duty	Duty	Note 3	47.5	50	52.5	%
Clock Rise Time	trcp	Note 3			50	ns
Clock Fall Time	ticp	Note 3			50	ns
lastrical Characteristics IT - 2	0 to 175°C	CNID-ON NoEVILES	2			10
lectrical Characteristics//a=-2	U TO +/5 C	, GND=00, VDD=5V15%	min	typ	max	unit
Input Leak Current	lin	VIN-0 to VDD, CS, E, RS, R/W, RES	- 5		5	μA
Current Dissipation	Icci	CR oscillation, fosc- 600kHz		2	4	mΑ
Current Dissipation	CC2	External clock, fCP=2.5MHz		3	5	mΑ
Pull-up Current	TPL	VIN=GND, DB0to?, RD0to?, MD0to?		10	20	μA
(Note 1)		(Note 2)	(Note	3)		
R		Open	Th	T		
		0.7Vcc	-f		4	[
		Oscillator CR	Ţ		Ŧ	
0f=15x5+5%	L			- Du	$ty = -\frac{T}{Tb}$	<u>h</u> +T - X
Rf=39k2±2% (at fosc=600kHz typ.)				34 	10	

Timing Characteristics

Bus read/write operation 1

READ CYCLE



Ta=-20to+75°C. VDD=5V±5%. GND=0V

Na	Item	Symbol	min typ	max	unit	Conditions
1	Address set-up time	LAS	90	p	ns	
2	Address hold time	IAH	10		n\$	
3	Data delay time (read)	TDDR		140	ns	CL≕50pF
4	Data hold time (read)	TDHR	10		ns	
5	Data set-up time (write)	tDSW	220		ns	
6	Data hold time (wirte)	to-tw	20		ns	

Note: Definition of the test waveform



The input terminals are driven at 2.4V and 0.45V. Timing is measured at 1.5V.

Bus read/write operation 2

DATA READ CYCLE

DATA WRITE CYCLE



Ta=-20to+75°C, Voo=5V±5%, GND=0V

No	Item	Symbol	min	typ	max unit	Instruction register value
1	Read cycle time	trcy			(Ap+2)×10 ³ +200 /ns	0 DH
2	Write cycle time	twoy1			(2 Hp+2)×10 ³ FOSC +200 ns	0 EH. 0 FH
2	Write cycle time	twoy2			(Hp+2)×103 +200 ns	0 CH
2	Write cycle time	twcy3			2000 Posc +200 ns	00H, 01H, 02H, 03H 04H, 08H, 09H 0 AH, 0 BH

Notes: (1) In the character mode, Hp is the number of horizontal dots per character in a character display. In the graphic mode, Hp indicates how many bits from RAM appear in a 1-byte display.

- (2) FOSC is the oscillating frequency, expressed in MHz.
- (3) All measurement points are at 1.5V.
- Parallel operation (at master mode)



Ta= 20to +75°C. VDD= 5 V± 5%. GND= 0 V

No.	Item	Symbol	min	typ	max	unit	Conditions
۱	SYNC delay time	tDSY			100	ns	
2	SYNC pulse width	twsy	350			ns	

Notes: (1) All output terminals are under no load. (2) All measurement points are at 0.5Vpp.

Interface with external RAM and ROM



READ CYCLE Ta=-20to+75°C. Voo - 5 V± 5 %. GND 0 V

Na	ltem	Symbol min typ	max	unit	Conditions
1	MA0-15 read address delay time	TOMAR	95	ns	
2	MD0-7 · RD0-7 set-up time	tSMDR 105	1	ns	

WRITE CYCLE Ta-20to+75C. VDD= 5 V # 5%. GND= 0 V

Na	Item	Symbol	min	typ	max	unit	Conditions
3	Memory address set-up time	tsmaw	50			ns	
4	WE pulse width	twwe	350			ns	
5	Memory data set-up time	tSMDW	250			ns	
6	Memory address hold time	thmaw	50			ns	······
7	Memory data bold time	thmow	50			ns	

Notes: (1) All output terminals are under no load.

(2) All measurement points are at 1.5V.

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Interface with the driver LSI

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Ta=-20to+75℃.	$Voo = 5 V \pm 5 \%$.	GND=0
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No	Item	Symbol	min typ	max	unit	Conditions
1	Clock cycle time	tevc (400		ns	
2	Clock phase difference	tDCL	\mathbb{R}	100	ns	
3	Clock rise/fall time	ICRE	• //	30	ns	
4	D1-2 phase difference	tOD		100	ns	
5	MA, MB phase difference	tOMA		200	ns	
6	FLM phase difference	torm		200	ns	

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Notes: (1) All output terminals are under no load. (2) All measurement points other than those specified are at 0.5VDD.



 When the ROM is extended, MA0 to MA11 are used for RAM addresses and MA12 to MA15 are used for the extended ROM.

Function of each block

Register

The LC7981 has 5 types of registers - the instruction register, data input register, data output register, dot register, and mode control register.

The instruction register stores such instruction codes as the start address, cursor address specification, etc. It consists of 4 bits, and the lower 4 bits of the data bus, DB0 to DB3, are written into it.

The data input register temporarily stores data to be written into the external RAM, dot register, and mode control register. It consists of 8 bits.

The data output register temporarily stores data to be read from external RAM, and consists of 8 bits. When the cursor address is written into the cursor address counter via the data input register and the memory read instruction is set in the instruction register, data in external RAM is read into the data output register by internal operation. With the next instruction, the MPU reads the data output register, and completes data transfer to the MPU.

The dot register stores dot information such as the character pitch, the number of vertical dots, etc. Data sent from the MPU is written into the dot register via the data input register.

The mode control register stores LCD status information such as display on/off and cursor on/off/blink. It consists of 6 bits. Data sent from the MPU is written into this register via the data input register.

Busy flag

When the busy flag is "1", the LC7981 is operating internally. At this time, the next instruction cannot be accepted. The busy flag is output to DB7 when RS=1, RW=1. The next instruction must be written after ensuring that the busy flag is "0". When the maximum value of the read cycle time or write cycle time has been passed after the execution of the preceding data read instruction or data write instruction, the next instruction can be executed without checking the busy flag.

Dot counter

The dot counter generates LC display timing according to the contents of the dot register.

Refresh address counter

The refresh address counter controls addresses of the external RAM, character generator ROM, extended ROM and is available in two types — refresh address counter (1) and refresh address counter (2). The former is for the upper screen, and the latter for the lower screen. In the graphic mode, 16-bit data is output and used as the address signal for the external RAM. In the character mode, the high-order 4 bits are ignored and 4 bits of the row address counter are output instead. The 4 bits are used as the address of the extended ROM.

The character generator ROM has a total of 7360 bits and stores data on 192 kinds of characters. Character codes from the external RAM and row codes from the row address counter are added to address signals, and ROM outputs 5-bit dot data.

There are 192 kinds of character fonts, of which 160 are 5 x 7 and 32 are 5 x 11. With extended ROM, character fonts can be increased to 256 kinds sized 8 x 16.

Cursor address counter

The cursor address counter is a 16-bit counter which can be preset by instruction. When data is read from or written into external RAM (i.e., read/write of display dot data or character codes), the counter retains the addresses. The value indicated on the cursor address counter is automatically incremented by 1 when instructions to read/write display data and to perform bit set/clear are issued.

Cursor signal generator

In the character mode, the cursor can be displayed by means of instructions. The cursor is generated automatically when the cursor address counter and the row address counter reach the specified value.

Parallel-serial conversion

The two parallel-serial conversion circuits simultaneously transfer parallel data from the external RAM, character generator, and extended ROM to the upper and lower LC screen drive circuits as serial data.

Pin Function

Description	Pin No.	Function
DB0 to 7	21 to 28	Data bus Three-state I/O common terminal, terminal for transmitting/receiving data to/from the MPU.
<u>CS</u>	15	Chip select Selection allowed when CS=0
R/W	17	Read/write R/W=1 MPU ← LC7981 R/W=0 MPU → LC7981
RS	18	Register select RS=1 instruction register RS=0 data register
E	16	Enable Data is written on the negative transition of E. Data can be read while E=1.
CR, R, C	6, 7, 8	Terminals for the CR oscillator
RES	14	Reset Setting RES to 0 selects display OFF, slave mode, and Hp=6.
MA0 to 15	1 to 4 49 to 60	Address output for the display RAM. For character display, raster address for external CG is output at MA12 to 15.
MD0 to 7	30 to 37	Display data bus Three-state I/O common terminals,
RD0 to 7	38 to 45	ROM data input Dot data from the external character generator is input.
WE	13	Write enable Display RAM write signal.
CL2	46	Display data shift clock signal.
CL1	11	Display data latch signal.
FLM	10	Frame signal.
МА	19	LC drive signal AC signal A system
мв	5	LC drive signal AC signal B system
D1, D2	47, 48	Display data serial output D1 for the upper screen D2 for the lower screen
СРО	9	Clock for slave
SYNC	12	Sync signal for parallel operation Three-state input/output common terminal Master mode Sync signal is output. Slave mode Sync signal is input.

Display control instruction

Display is controlled by writing data into the instruction register and 13 data registers. The instruction register and the data register are distinguished by the RS signal. First, write 4-bit data in the instruction register when RS=1, then specify the code of the data register. Next, with RS=0, write 8-bit data in the data register, which executes the specified instruction.

A new instruction cannot be accepted while an old instruction is being executed. As the Busy flag is set under this condition, write an instruction only after reading the Busy flag and making sure that it is 0.

However, the next instruction can be executed without checking the busy flag when the maximum read cycle time or the write cycle time has been exceeded after execution of the previous data read instruction or the data write instruction. The busy flag does not change when data is written into the instruction register (RS=1). Therefore, the busy flag need not be checked immediately after writing data into the instruction register.

1) Mode control

Write code "00H" (in hexadecimal notation) in the instruction register and specify the mode control register.

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2/	DB1	DB0
Instruction register	0	1	0	0	0	0	0	Ø	0	0
Mode control register	0	0	0	0		MODE	Data			

A

DB5	DB4	DB3	DB2	DB1	DB0/	Cursor/blink	CG	Graphic/character display
1		0	0			Cursor OFF	U	
	1 3	0	1			Cursor ON	C L	
		1	0			Cursor OFF character blink	iite:	
1	1	1	1			Cursor blink	B	A
Ó	Ó	0	0			Cursor OFF	g	Character display
		0	1			Cursor ON	al (
		1	0			Cursor ØFF character blink	terr	
		1	N			Cursor blink	ă	
		0	O		0		\ge	Graphic mode
Display ON/OFF	Master/slave	Blink	Cursor	Mode	External/ built-in CG			
āð	- W	iii	8	Ŵ	S built		12	



2) Setting the character pitch

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	0	0	D	0	0	0	1
Character pitch register	0	0		(Vp-	1) Bina	ary	0	14	40-13	Binary

Vp is the number of vertical dots per character. Determine Vp with the pitch between two vertically placed characters taken into consideration. This value is meaningful only in the character display mode: It is invalid in the graphic mode.

In character mode, Hp indicates the number of horizontal dots per character, from the leftmost part of one character to the leftmost part of the next. In the graphic mode, Hp indicates how many bits (or dots) from RAM appear in a 1-byte display.

Hp must take one of the following three values.

		DB0	D81	DB2	HP
haracter pitch 6	Horizonta	1	0	1	6
	4	0	1	1	7
8	4	1	1	1	8

3) Setting the number of characters

Register	R/W	RS	DB7	DB6	DB5	OB4	DB3	DB2	DB1	DB0
Instruction register	C	1	0	6	0	0	B	0	1	0
Character number register	C	0			\bigcirc	(Hy) Bina	iry		

In the character display mode, H_N indicates the number of characters in the horizontal direction. In the graphic mode, it indicates the number of bytes in the horizontal direction. The total number of dots positioned horizontally on the screen n is given by the formula

 $n = Hp \times H_N.$

Even numbers in the range 2 to 256 (decimal) can be set as HN.

4) Setting the time division number (display duty)

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	0	0	0	0	0	1	t
Time division register	0	0				(Nx-	1)Bina	ary	50 	

Consequently, 1/Nx is the display duty.

Decimal numbers within the range 1 to 256 can be set as Nx.

5) Setting the cursor position

Register	R/W	RS	DB7	DB6	D85	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	0	0	٥	0	1	0	0
Cursor position register	0	0	0	0	0	O		(CP-	1) Bina	irγ

In the character display mode, Cp indicates the line at which the cursor is displayed. For example, when Cp=8 (decimal) is specified, the cursor is displayed beneath the character of the 5 x 7 dot-font. The horizontal length of the cursor equals Hp (the horizontal character pitch). Decimal values in the range 1 to 16 can be assigned to Cp. When the value is less than the vertical character pitch Vp (Cp \approx Vp), display priority is given to the cursor (provided the cursor display is ON). The cursor is not displayed when CP < Vp. The horizontal length of the cursor equals Hp.

6) Setting the display start lower address

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DBO
Instruction register	D	1	0	0	0	0	t	0	0	0
Display start address register (lower byte)	0	0		1	(start a	ddress lo	wer byte) binary		

7) Setting the display start upper address

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DBO
Instruction register	0	1	0	0	0	0	1	Û.	0	1
Display start address register (upper byte)	0	0			(start a	address u	pper byt	e) binary	1	ľ.

This instruction writes the display start address value in the display start address register. The display start address is the RAM address at which data to be displayed at the leftmost position of the top line of the screen is stored. The start address consists of 16 bits (upper and lower).

8) Setting the cursor (lower) address (RAM read/write lower address)

Register	R/W	RS	DB7	DBC	DB5	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	0	0	0	1	0	1	0
Cursor address counter (lower byte)	D	0			(cursor	address	ower byt	e) binary	1	

9) Setting the cursor (upper) address (RAM read/write upper address)

Register	R/W	/RS	DB?	DB6	DBS	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	0	0	0	1	0	1	1
Cursor address counter (upper byte)	9	0			(cursor	address	upper by	te) binar	y	

This instruction writes the cursor address value in the cursor address counter. The cursor address indicates the address for exchanging display data and character codes with RAM. In other words, data at the address specified by the cursor address is read from or written into RAM. In character display, the cursor is displayed at the position specified by the cursor address.

The cursor address is divided into a lower address (8 bits) and an upper address (8 bits). It should be set in accordance with the following rules.

1	To rewrite (set) both lower and upper addresses:	First set the lower address, then the upper.
2	To rewrite the lower address:	Always reset the upper address after setting the lower address.
3	To rewrite the upper address only:	Set the upper address. It is necessary to reset the lower address.

The cursor address counter is a 16-bit up-counter with set/reset functions: when the Nth bit goes from 1 to 0, the count of the (N + 1)th bit increments by one. Accordingly, when the lower address is set so that the lower MSB (8th bit) changes from 1 to 0, the LSB (1st bit) of the upper counter must increment by one. When setting the cursor address, set the lower and upper addresses as a 2-byte continuous instruction.

10) Writing display data

Regisiter	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DBO
Instruction register	C	1	0	0	0	0	1	1	O	0
RAM	0	0	MSB (pattern (data, cha	racter co	de)	1	Ls	B

Write code "OCH" in the instruction register. Then, write 8-bit data with RS=0, and the data is written into RAM as display data or character codes at the address specified by the cursor address counter. After writing, the count of the cursor address counter increments by 1.

11) Reading display data

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	0	0	0	4	1	0	1
RAM	1	0	MSB	(pattern o	data, cha	racter co	de)	* //	LS	в

Write "ODH" in the instruction register. Then, establish the read status with RS=0, and data in the RAM can be read. The procedure for reading data is as follows:

This instruction outputs the contents of the data output register to DBO to 7, then transfers the RAM data indicated by the cursor address to the data output register. It then increments the cursor address by 1, which means that correct data cannot be read in the first read operation. The specified value is output in the second read operation. Accordingly, a dummy read operation must be performed once when reading data after setting the cursor address.

12) Bit clear

Register	R/W	RS	D87	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	o	0	0	1	1	1	0
Bit clear	0	٥	0	0	o	0	D	(1	VB-1)	Binary

13) Bit set

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Instruction register	0	1	0	0	O	0	1	1	1	1
Bit set	0	Q	0	0	0	0	0	(1	VB-1)	Binary

As the bit-clear or bit-set instruction, 1 bit of a 1 byte of data in display RAM is set to 0 or 1. The bit specified by NB is set to 0 for the bit-clear instruction and 1 for the bit-set instruction. The RAM address is specified by the cursor address, which is automatically incremented by 1 at the completion of the instruction. NB is a value in the range from 1 to 8. The LSB is indicated by NB=1, and the MSB by NB=8.

14) Reading the BUSY flag

Register	R/W	RS	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Busy flag	1	1	1/0	*						

The busy flag is output to DB7 when read mode is established with RS=1. The busy flag is set to 1 while any of the instructions 1) through 13) is being executed. It is set to 0 at the completion of the execution, allowing the next instruction to be accepted. No other instruction can be accepted when the busy flag is 1. Accordingly, before writing an instruction and data, it is necessary to ensure that the busy flag is 0. However, the next instruction can be executed without checking the busy flag when the maximum read cycle time or the write cycle time has been exceeded after execution of the previous data read instruction or the data write instruction.

The busy flag does not change when data is written into the instruction register (RS=1). Therefore, the busy flag need not be checked immediately after writing data into the instruction register. Specification of the instruction register is unnecessary to read the busy flag.

The relation between the LCD panel display and Hp, HN, Vp, Cp, and Nx.



Symbol	Description	Contents	Value
Hp .	Horizontal character pitch	Character pitch in the horizontal direction	6 to 8 dots
н _N	Number of characters in the horizontal direction	Number of characters (digits) per horizontal line or the number of words per line (graphic)	Even digits in the range 2 to 256
Vp	Vertical character pitch	Character pitch in the vertical direction	1 to 16 dots
Ср	Cursor position	The line number at which the cursor is to be displayed	1 to 16 lines
Nx	Number of lines in the vertical direction	Display duty	1 to 256 lines

Note)

When the number of vertical dots on the screen is m and that of horizontal dots is n,

1/m = 1/Nx = display duty $n = Hp \times H_N$ m/Vp = number of display lines $Cp \leq Vp$





Sample application circuit (1)



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Sample application circuit (2) [Composition of graphic display and character display]





Built-in character generator

Lower 4bit	0010	0011	0100	0101	0110	0111	1010	1011	1100	1101	1170	1111
××××0000		0	Ð	P	•	p			-9	7.	124	R
××××0001		1	A	Q	ā	4		P	×	Ľ.	ä	
××××0010		2	В	R	b	ŀ	ľ	1	/iji			jeji
××××0011	#	3	Ľ.	5	C .	<u>s</u> .		<i>P</i> ,	Ŧ	HE.	2	.:.?
****0100	\$	4	D	T	d	1.			ŀ.	* * *] .4	9
****0101	<u>.</u>	5	E	Ū	•	1.1			*	1	G	ü
****0110	8:	6	F	IJ	Æ	4	Ą	17	/ <u></u>	=	ρ	Σ
****0111	:	7	B	<u>k</u> ľ	2	<u>).</u>]	P	/#	$\overline{\mathbb{X}}$		C]	Л
****1000	Ċ	8	K	X	h		A	ŋ		Ņ	.ŗ	×
***×1001)	7	Ţ	ų	1	<u>}</u>	<u>ري</u> ند	٠Ţ	ļ	ιĿ	-1	Ц
××××1010	:4:		Ţ	Z	Å	Z	Л.		i'i	Į,	j	
****1011	4	*	K	Ţ	1:	{	7	ij	Ŀ	П	*	丙
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